

# Absolute Maximum Ratings \* Ta = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	-50	V
V <sub>CEO</sub>	Collector-Emitter Voltage	-50	V
V <sub>EBO</sub>	Emitter-Base Voltage	-10	V
Ic	Collector Current	-100	mA
T <sub>STG</sub>	Storage Temperature Range	-55~150	°C
TJ	Junction Temperature	150	O∘C
P <sub>C</sub>	Collector Power Dissipation, by R <sub>0JA</sub>	200	mW

\* These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

## Thermal Characteristics\* Ta=25°C unless otherwise noted

Symbol	Parameter Parameter	Max	Units
R <sub>0JA</sub>	Thermal Resistance, Junction to Ambient	600	°C/W
* Minimum land pac	size.		

## **Electrical Characteristics**\*

S^	$T_C = 25^{\circ}C$ unless otherwise noted	
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Symbol	Parameter	Test Condition	MIN	Тур	MAX	Units
V(BR)CBO	Collector-Emitter Breakdown Voltage	Ic = -10 uA, IE = 0	-50	52	- 0Z	V
V(BR)CEO	Collector-Base Breakdown Voltage	Ic = -100 uA, Iв = 0	-50	14 14	100000	V
Ісво	Collector-Cutoff Current	V <sub>CB</sub> = -40 V, I <sub>E</sub> = 0			-0.1	uA
hfe	DC Current Gain	Vce = -5 V, Ic = -5mA	30			
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	lc = -10 mA, lв = -0.5 mA			-0.3	V
f⊤	Current Gain - Bandwidth Product	Vce = -10V, Ic = -5 mA		200		MHz
Ccb	Output Capacitance	V <sub>CB</sub> = -10 V, I <sub>E</sub> = 0, f = 1.0 MHz		5.5		pF
VI(off)	Input Off Voltage	Vce = -5 V, Ic = -100uA	-0.3			V
VI(on)	Input On Voltage	Vce = -0.3V, Ic = -20mA	İ		-2.5	V
R1	Input Resistor		3.2	4.7	6.2	KΩ
R1/R2	Resistor Ratio		0.42	0.47	0.52	

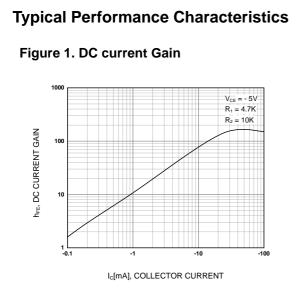


Figure 2. Input On Voltage

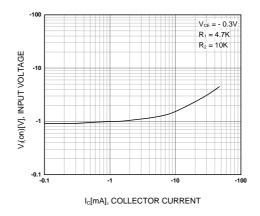


Figure 3. Input off Voltage

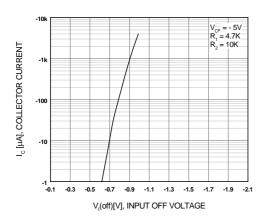
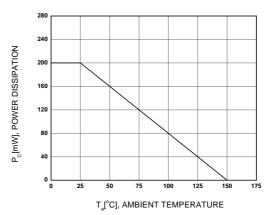
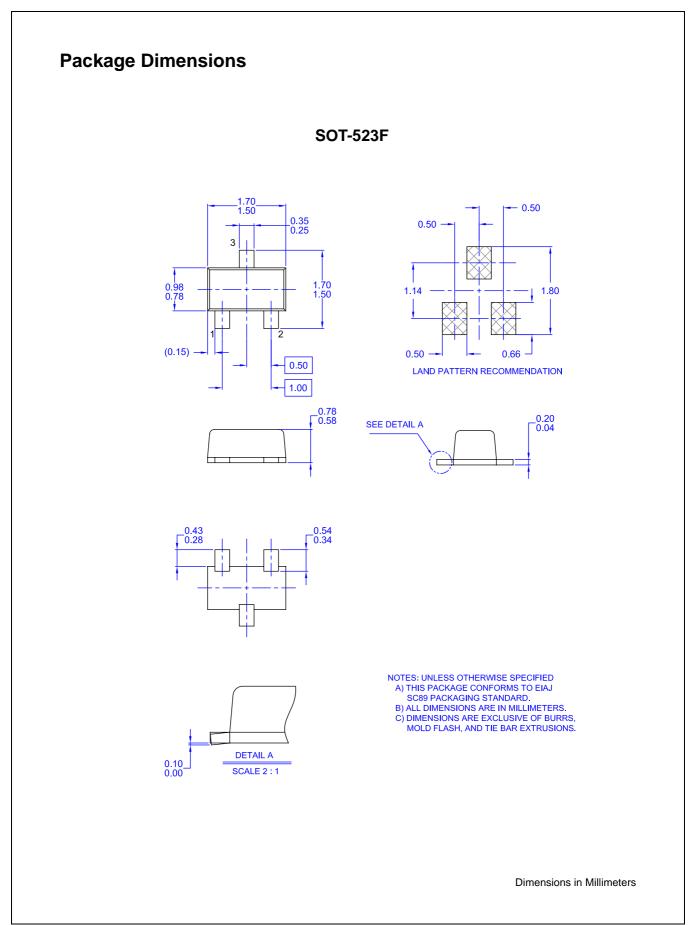


Figure 4. Power Derating





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